

**General Description**

Switching regulator and DC-DC Converter applications.

It's mainly suitable for power management in PC,  
portable equipment and battery powered systems.

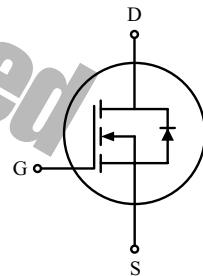
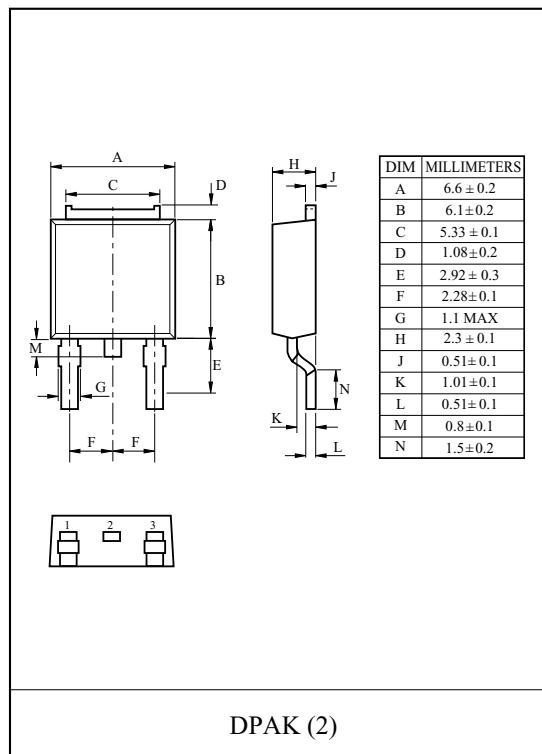
**FEATURES**

- $V_{DSS}=30V$ ,  $I_D=30A$ .
- Low Drain-Source ON Resistance.
- $R_{DS(ON)}=18m\Omega$  (Max.) @  $V_{GS}=10V$
- $R_{DS(ON)}=36m\Omega$  (Max.) @  $V_{GS}=4.5V$
- Super High Dense Cell Design.
- High Power and Current Handling Capability.

**MAXIMUM RATING (Ta=25°C)**

| CHARACTERISTIC                               |                 | SYMBOL       | RATING    | UNIT |
|--|-----------------|--------------|-----------|------|
| Drain-Source Voltage                         |                 | $V_{DSS}$    | 30        | V    |
| Gate-Source Voltage                          |                 | $V_{GSS}$    | $\pm 20$  | V    |
| Drain Current                                | DC              | $I_D$ *      | 30        | A    |
|  | Pulsed (Note 1) | $I_{DP}$ *   | 75        |      |
| Source-Drain Diode Current                   |                 | $I_S$        | 20        | A    |
| Drain Power Dissipation ( $T_c=25^\circ C$ ) |                 | $P_D$ *      | 50        | W    |
| Maximum Junction Temperature                 |                 | $T_j$        | 150       |      |
| Storage Temperature Range                    |                 | $T_{stg}$    | -55 ~ 150 |      |
| Thermal Resistance, Junction to Case         |                 | $R_{thJC}$   | 3         | /W   |
| Thermal Resistance, Junction to Ambient      |                 | $R_{thJA}$ * | 50        | /W   |

\* : Surface Mounted on FR4 Board, t = 10sec.



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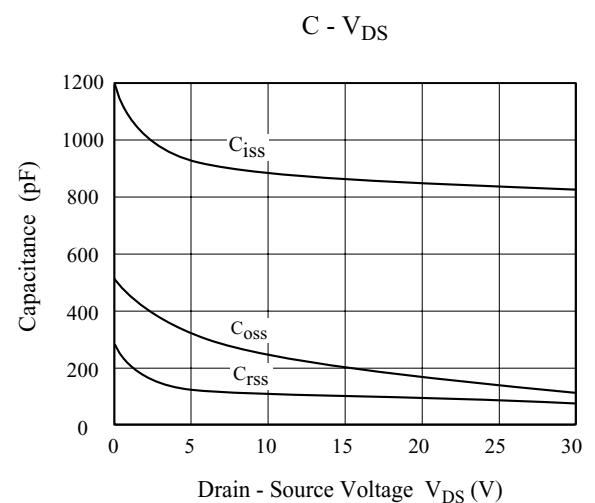
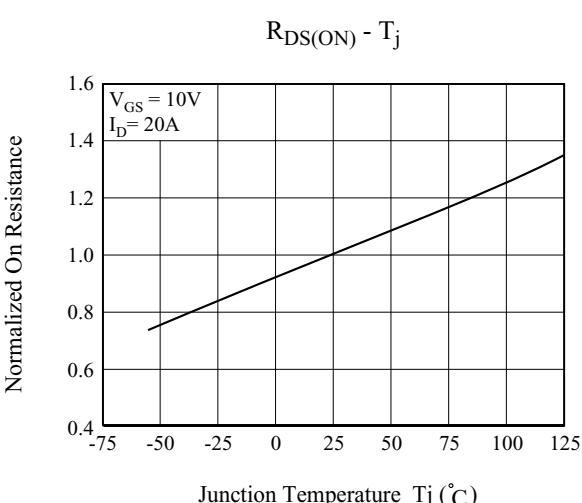
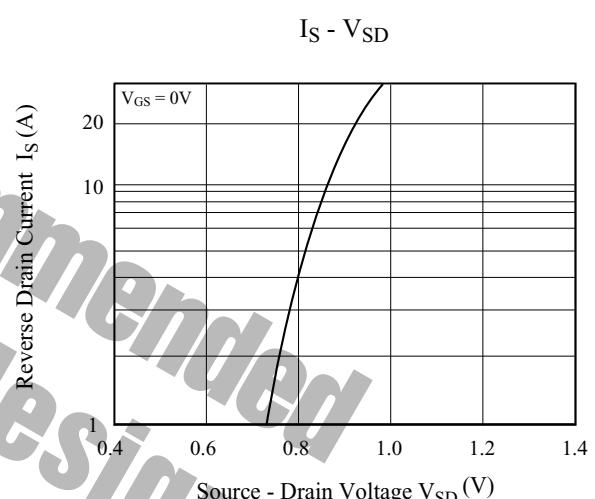
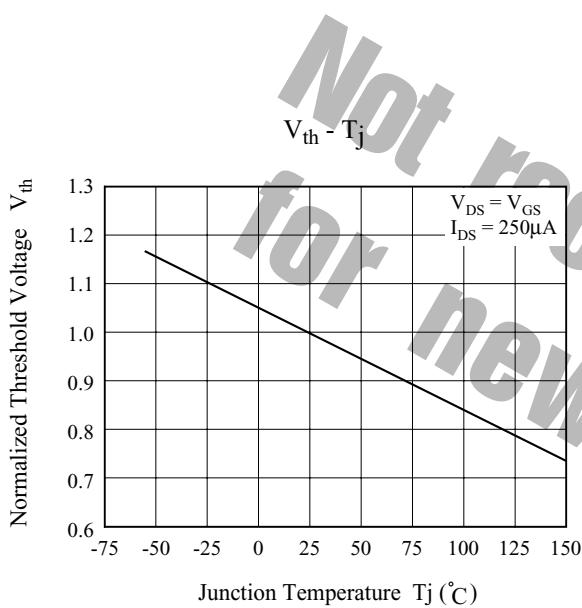
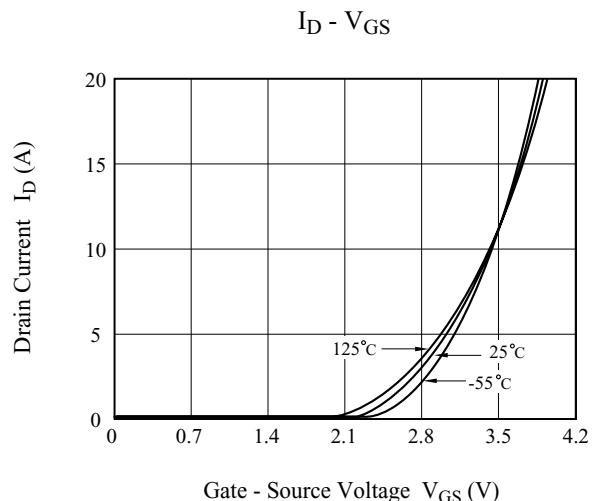
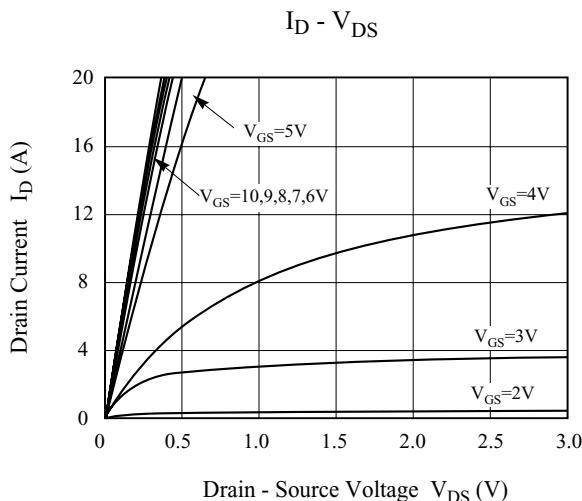
## ELECTRICAL CHARACTERISTICS (Ta=25 °C)

| CHARACTERISTIC                     | SYMBOL              | TEST CONDITION  | MIN. | TYP. | MAX. | UNIT |
|------------------------------------|---------------------|---|------|------|------|------|
| <b>Static</b>                      |                     |   |      |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | I <sub>D</sub> =250 μA, V <sub>GS</sub> =0V,  | 30   | -    | -    | V    |
| Drain Cut-off Current              | I <sub>DSS</sub>    | V <sub>GS</sub> =0V, V <sub>DS</sub> =24V   | -    | -    | 1    | μA   |
| Gate Leakage Current               | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V  | -    | -    | ±100 | nA   |
| Gate Threshold Voltage             | V <sub>th</sub>     | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA                                       | 1.0  | 1.7  | 2.5  | V    |
| Drain-Source ON Resistance         | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A (Note 1)  | -    | 13   | 18   | m    |
|                                    |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =12A (Note 1)   | -    | 23   | 36   |      |
| ON State Drain Current             | I <sub>D(ON)</sub>  | V <sub>GS</sub> =10V, V <sub>DS</sub> =10V (Note 1)   | 40   | -    | -    | A    |
| Forward Transconductance           | g <sub>fs</sub>     | V <sub>DS</sub> =10V, I <sub>D</sub> =20A (Note 1)  | -    | 16   | -    | S    |
| Source-Drain Diode Forward Voltage | V <sub>SD</sub>     | I <sub>S</sub> =20A, V <sub>GS</sub> =0V (Note 1)   |      | 0.94 | 1.3  | V    |
| <b>Dynamic (Note 2)</b>            |                     |   |      |      |      |      |
| Total Gate Charge                  | Q <sub>g</sub>      | V <sub>DS</sub> =15V, I <sub>D</sub> =20A, V <sub>GS</sub> =10V (Fig.1)                         | -    | 15.3 | -    | nC   |
|                                    |                     | V <sub>DS</sub> =15V, I <sub>D</sub> =20A, V <sub>GS</sub> =4.5V (Fig.1)                        | -    | 7.5  | -    |      |
| Gate-Source Charge                 | Q <sub>gs</sub>     | V <sub>DS</sub> =15V, I <sub>D</sub> =20A, V <sub>GS</sub> =10V (Fig.1)                         | -    | 2.3  | -    |      |
| Gate-Drain Charge                  | Q <sub>gd</sub>     |   | -    | 4.2  | -    |      |
| Turn-on Delay time                 | t <sub>d(on)</sub>  | V <sub>DD</sub> =15V, I <sub>D</sub> =1A,<br>V <sub>GS</sub> =10V, R <sub>G</sub> =6<br>(Fig.2) | -    | 7.6  | -    | ns   |
| Turn-on Rise time                  | t <sub>r</sub>      |   | -    | 23.5 | -    |      |
| Turn-off Delay time                | t <sub>d(off)</sub> |   | -    | 15.8 | -    |      |
| Turn-off Fall time                 | t <sub>f</sub>      |   | -    | 5    | -    |      |
| Input Capacitance                  | C <sub>iss</sub>    | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1.0MHz   | -    | 872  | -    | pF   |
| Output Capacitance                 | C <sub>oss</sub>    |   | -    | 196  | -    |      |
| Reverse transfer Capacitance       | C <sub>rss</sub>    |   | -    | 105  | -    |      |

Note 1) Pulse test : Pulse width 300μs, Duty Cycle 2%.

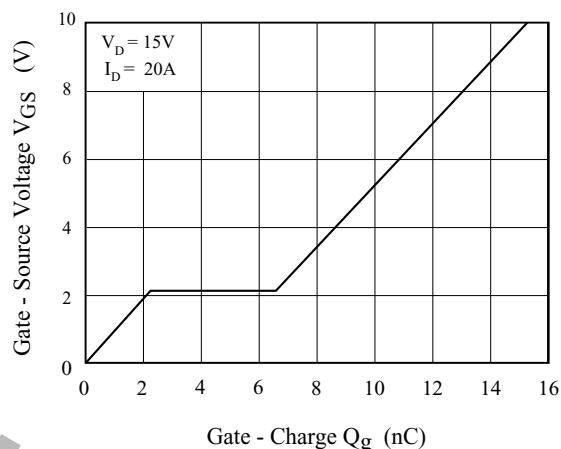
Note 2) Guaranteed by design. Not subject to production testing.

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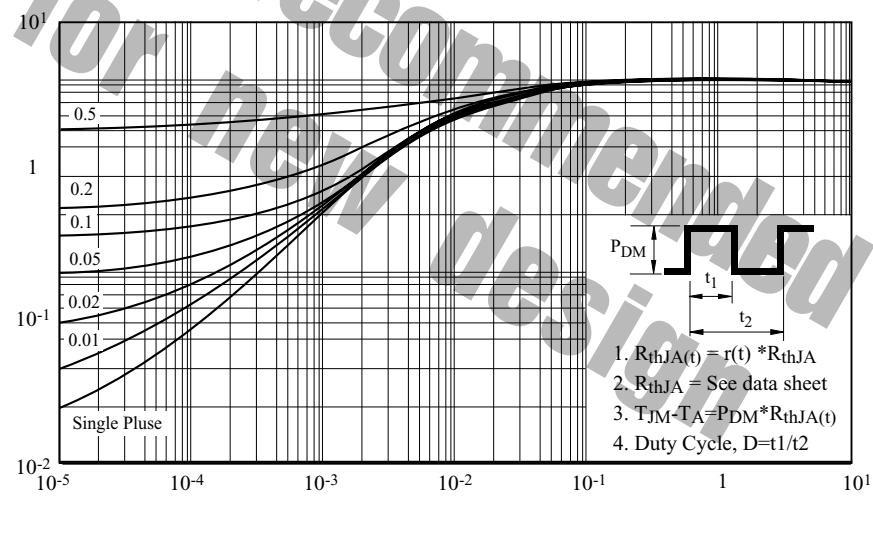
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$Q_g - V_{GS}$



Normalized Transient Thermal Resistance

$R_{th}$



Square Wave Pulse Duration (sec)

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Fig. 1 Gate Charge

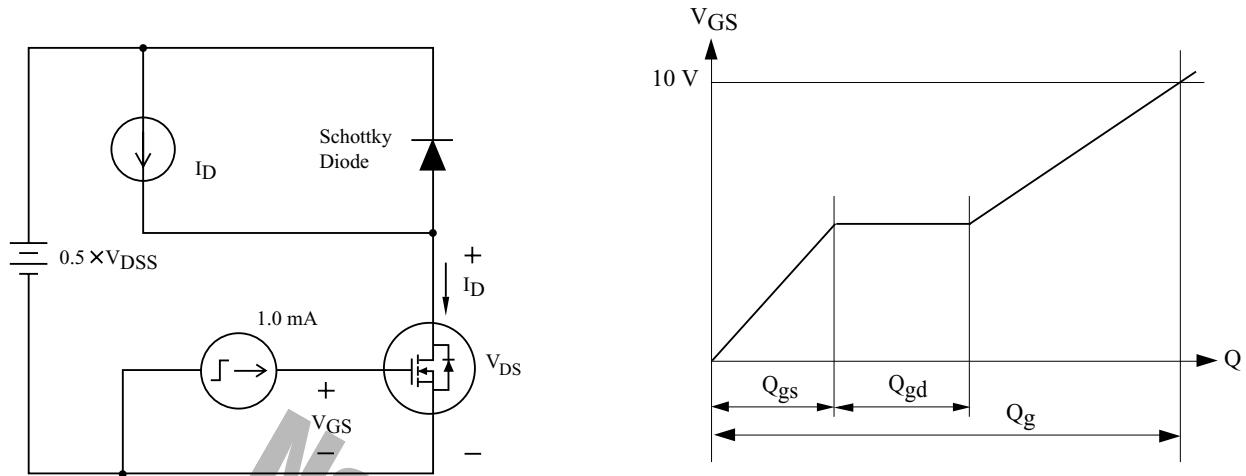


Fig. 2 Resistive Load Switching

